Preferred Device

Advance Information

Power MOSFET 15 Amps, 400 Volts

N-Channel TO-220 and D2PAK

Designed for high voltage, high speed switching applications in power supplies, converters, power motor controls and bridge circuits.

Features

- Higher Current Rating
- Lower RDS(on)
- Lower Capacitances
- Lower Total Gate Charge
- Tighter V_{SD} Specifications
- Avalanche Energy Specified

Typical Applications

- Switch Mode Power Supplies
- PWM Motor Controls
- Converters
- Bridge Circuits

MAXIMUM RATINGS (T_C = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Drain-Source Voltage	VDSS	400	Vdc
Drain–Gate Voltage ($R_{GS} = 1.0 \text{ M}\Omega$)	V _{DGR}	400	Vdc
Gate–Source Voltage – Continuous – Non–Repetitive (t _p ≤10 ms)	V _{GS} V _{GSM}	±20 ±40	Vdc
Drain - Continuous - Continuous @ 100°C - Single Pulse (t _p ≤ 10 μs)	I _D	15 12 53	Adc
Total Power Dissipation Derate above 25°C	PD	202 1.61	Watts W/°C
Operating and Storage Temperature Range	T _J , T _{stg}	-55 to 150	°C
Single Drain–to–Source Avalanche Energy – Starting $T_J = 25^{\circ}C$ ($V_{DD} = 100 \text{ V}$, $V_{GS} = 10 \text{ Vdc}$, $I_L = 15 \text{ A}$, $L = 6 \text{ mH}$, $R_G = 25 \Omega$)	EAS	675	mJ
Thermal Resistance - Junction-to-Case - Junction-to-Ambient - Junction-to-Ambient (Note 1.)	R _θ JC R _θ JA R _θ JA	0.62 62.5 50	°C/W
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 10 seconds	TL	260	°C

When surface mounted to an FR4 board using the minimum recommended pad size.

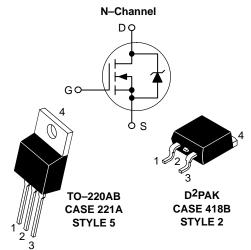
This document contains information on a new product. Specifications and information herein are subject to change without notice.



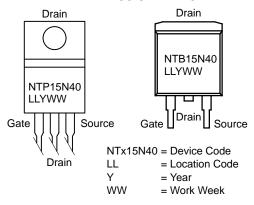
ON Semiconductor™

http://onsemi.com

15 AMPERES 400 VOLTS RDS(on) = 260 m Ω



MARKING DIAGRAMS AND PIN ASSIGNMENTS



ORDERING INFORMATION

Device	Package	Shipping
NTP15N40	TO-220AB	50 Units/Rail
NTB15N40	D ² PAK	50 Units/Rail
NTB15N40T4	D ² PAK	800/Tape & Reel

Preferred devices are recommended choices for future use and best overall value.

ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted)

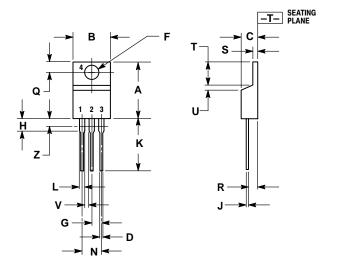
Ch	Symbol	Min	Тур	Max	Unit	
OFF CHARACTERISTICS						
Drain-to-Source Breakdown Vo	V(BR)DSS	400		-	Vdc	
Temperature Coefficient (Pos	itive)		-	510	-	mV/°C
Zero Gate Voltage Collector Cu (V _{DS} = 400 Vdc, V _{GS} = 0 Vd (V _{DS} = 400 Vdc, V _{GS} = 0 Vd	IDSS	- -	_ _	10 100	μAdc	
Gate-Body Leakage Current (V	I _{GSS(f)} I _{GSS(r)}	_ _	_ _	100 100	nAdc	
ON CHARACTERISTICS (Note 2)		!	-		*
Gate Threshold Voltage ID = 0.25 mA, VDS = VGS Temperature Coefficient (Neg	VGS(th)	2.0	2.5 6.8	4.0 _	Vdc mV/°C	
Static Drain-to-Source On-Res	R _{DS(on)}	_	230	260	mOhm	
Drain-to-Source On-Voltage (VGS = 10 Vdc, I _D = 15 Adc) (VGS = 10 Vdc, I _D = 7.5 Adc,	V _{DS(on)}	_	_	4.7 4.1	Vdc	
Forward Transconductance (V _D		a-c	10	13	-	mhos
	<u>13 vac, 10 = 7.5 Aac)</u>	9FS	10	13		111103
Input Capacitance		C _{iss}	_	1800	2520	pF
Output Capacitance	$(V_{DS} = 25 \text{ Vdc}, V_{GS} = 0 \text{ Vdc},$	C _{oss}	_	630	880	
Transfer Capacitance	f = 1.0 MHz)	C _{rss}	_	40	80	
SWITCHING CHARACTERISTIC	S (Note 3.)	OISS		40	00	
Turn-On Delay Time	(Note 3.)	^t d(on)	_	13	30	ns
Rise Time	(V _{DD} = 200 Vdc, I _D = 15 Adc,	t _r	_	40	80	
Turn-Off Delay Time	$V_{GS} = 10 \text{ Vdc},$ $R_{G} = 9.1 \Omega)$	t _d (off)	_	49	100	1
Fall Time	1.6 – 3.1 22)	t _f	_	46	90	1
Gate Charge	(Vac - 220 Vdo In - 15 Ado	QT	_	37	50	nC
Ü		Q ₁	_	8.0		-
	$(V_{DS} = 320 \text{ Vdc}, I_{D} = 15 \text{ Adc}, V_{GS} = 10 \text{ Vdc})$	Q ₂	_	12	_	
		Q ₃	_	20	_	<u> </u>
SOURCE-DRAIN DIODE CHAR	ACTERISTICS	<u> </u>				<u> </u>
Forward On–Voltage (Note 2.)	(I _S = 15 Adc, V _{GS} = 0 Vdc) (I _S = 15 Adc, V _{GS} = 0 Vdc, T _J = 125°C)	V _{SD}	_ _	0.90 0.80	1.0	Vdc
Reverse Recovery Time		t _{rr}	_	290	_	ns
		ta	-	170	-	1
	(I _S = 15 Adc, V _{GS} = 0 Vdc, dis/dt = 100 A/μs)	t _b	-	120	-	1
Reverse Recovery Stored Charge	. ,		-	3.5	-	μС
NTERNAL PACKAGE INDUCTA	NCE					
Internal Drain Inductance (Measured from contact screw on tab to center of die) (Measured from the drain lead 0.25" from package to center of die)		LD	_ _	3.5 4.5	- -	nH
Internal Source Inductance (Measured from the source lea	LS	_	7.5	_		

Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.
 Switching characteristics are independent of operating junction temperature.

PACKAGE DIMENSIONS

TO-220 THREE-LEAD TO-220AB

CASE 221A-09 **ISSUE AA**



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

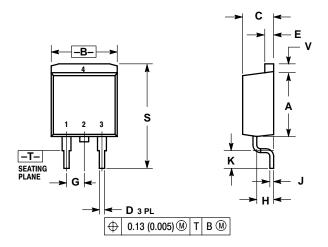
	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.570	0.620	14.48	15.75
В	0.380	0.405	9.66	10.28
C	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
Н	0.110	0.155	2.80	3.93
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
٧	0.045		1.15	
Z		0.080		2.04

STYLE 5: PIN 1.

GATE

- DRAIN SOURCE DRAIN 3.





NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.340	0.380	8.64	9.65	
В	0.380	0.405	9.65	10.29	
C	0.160	0.190	4.06	4.83	
D	0.020	0.035	0.51	0.89	
Е	0.045	0.055	1.14	1.40	
G	0.100 BSC		2.54 BSC		
Н	0.080	0.110	2.03	2.79	
J	0.018	0.025	0.46	0.64	
K	0.090	0.110	2.29	2.79	
S	0.575	0.625	14.60	15.88	
V	0.045	0.055	1.14	1.40	

- STYLE 2: PIN 1. GATE 2. DRAIN 3. SOURCE 4. DRAIN

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001-800-4422-3781 Email: ONlit-asia@hibbertco.com

JAPAN: ON Semiconductor, Japan Customer Focus Center

4-32-1 Nishi-Gotanda, Shinagawa-ku, Tokyo, Japan 141-0031

Phone: 81–3–5740–2700 Email: r14525@onsemi.com

ON Semiconductor Website: http://onsemi.com

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